

Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: B32774 ... B32778

Date: June 2018

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Metallized polypropylene film capacitors (MKP)

B32774 ... B32778

MKP DC link – high density series up to 480 μ F

Typical applications

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1:2013): 40/105/56

Construction

- Dielectric: Polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Capacitance values up to 480 μF
- High CV product, compact
- Good self-healing properties
- Over-voltage capability
- Low losses with high current capability
- High reliability
- Long useful life
- RoHS-compatible

Terminals

- Parallel wire leads, lead-free tinned
- 2-pin, 4-pin and 12-pin versions
- Standard lead lengths: 6 –1 mm

Marking

Manufacturer's logo and lot number, date code, rated capacitance (coded), capacitance tolerance (code letter) and rated DC voltage

Delivery mode

Bulk (untaped)





MKP DC link - high density series up to 480 μF

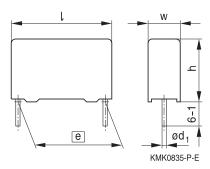
Dimensional drawings

| Number of wires | Lead spacing e ±0.4 | Lead diameter d ₁ ±0.05 | Туре |
|-----------------|---------------------|------------------------------------|---------|
| 2-pin | 27.5 | 0.8 | B32774D |
| 2-pin | 37.5 | 1.0 | B32776E |
| 2-pin | 37.5 | 1.0 | B32776T |
| 4-pin | 37.5 | 1.2 | B32776G |
| 4-pin | 37.5 | 1.2 | B32776T |
| 4-pin | 52.5 | 1.2 | B32778T |
| 4-pin | 52.5 | 1.2 | B32778G |
| 12-pin | 52.5 | 1.2 | B32778J |

Dimensions in mm

Dimensional drawings 2-pin versions

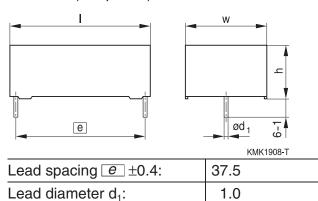
B32774D, B32776E



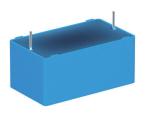
| | B32774D | B32776E |
|----------------------|---------|---------|
| Lead spacing e ±0.4: | 27.5 | 37.5 |
| Lead diameter d₁: | 8.0 | 1.0 |

Dimensions in mm

B32776T (low profile)



Dimensions in mm



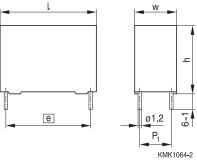




MKP DC link – high density series up to 480 μF

Dimensional drawings 4-pin versions

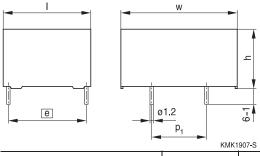
B32776G, B32778G



| | B32776G | B32778G |
|----------------------|---------|---------|
| Lead spacing e ±0.4: | 37.5 | 52.5 |
| Lead diameter d₁: | 1.2 | 1.2 |

Dimensions in mm

B32776T, **B32778T** (low profile)

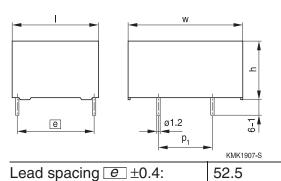


| | B32776T | B32778T |
|----------------------|---------|---------|
| Lead spacing e ±0.4: | 37.5 | 52.5 |
| Lead diameter d₁: | 1.2 | 1.2 |

Dimensions in mm

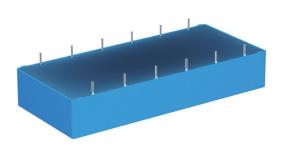
Dimensional drawing 12-pin version

B32778J



Lead diameter d₁: 1.2

Dimensions in mm







MKP DC link - high density series up to 480 μF

Overview of available types

| Lead spacing 27.5 mm | | | | | 37.5 mi | m | | | | |
|-----------------------|--------|-----|------|------|---------|-----|-----|-----|------|------|
| Туре | B32774 | | | | B32776 | | | | | |
| Page | 7 | | | | 8 | | | | | |
| V _R (V DC) | 450 | 800 | 1100 | 1300 | 450 | 575 | 800 | 900 | 1100 | 1300 |
| C _R (μF) | | | | | | | | | | |
| 1.5 | | | | | | | | | | |
| 2.0 | | | | | | | | | | |
| 2.7 | | | | | | | | | | |
| 3.0 | | | | | | | | | | |
| 3.3 | | | | | | | | | | |
| 3.5 | | | | | | | | | | |
| 3.9 | | | | | | | | | | |
| 5.0 | | | | | | | | | | |
| 6.8 | | | | | | | | | | |
| 7.0 | | | | | | | | | | |
| 7.5 | | | | | | | | | | |
| 8.0 | | | | | | | | | | |
| 8.5 | | | | | | | | | | |
| 9.0 | | | | | | | | | | |
| 10 | | | | | | | | | | |
| 12 | | | | | | | | | | |
| 13 | | | | | | | | | | |
| 14 | | | | | | | | | | |
| 15 | | | | | | | | | | |
| 16 | | | | | | | | | | |
| 20 | | | | | | | | | | |
| 22 | | | | | | | | | | |
| 25 | | | | | | | | | | |
| 27 | | | | | | | | | | |
| 30 | | | | | | | | | | |
| 35 | | | | | | | | | | |
| 40 | | | | | | | | | | |
| 45 | | | | | | | | | | |
| 50 | | | | | | | | | | |
| 60 | | | | | | | | | | |
| 65 | | | | | | | | | | |





MKP DC link - high density series up to 480 μF

Overview of available types

| Lead spacing | 52.5 mm | | | | | |
|-----------------------|---------|-----|-----|-----|------|------|
| Туре | B32778 | | | | | |
| Page | 11 | | | | | |
| V _R (V DC) | 450 | 575 | 800 | 900 | 1100 | 1300 |
| C _R (μF) | | | | | | |
| 14 | | | | | | |
| 20 | | | | | | |
| 25 | | | | | | |
| 27 | | | | | | |
| 30 | | | | | | |
| 35 | | | | | | |
| 38 | | | | | | |
| 40 | | | | | | |
| 42 | | | | | | |
| 45 | | | | | | |
| 50 | | | | | | |
| 55 | | | | | | |
| 58 | | | | | | |
| 60 | | | | | | |
| 70 | | | | | | |
| 75 | | | | | | |
| 80 | | | | | | |
| 90 | | | | | | |
| 100 | | | | | | |
| 110 | | | | | | |
| 120 | | | | | | |
| 130 | | | | | | |
| 150 | | | | | | |
| 170 | | | | | | |
| 180 | | | | | | |
| 200 | | | | | | |
| 210 | | | | | | |
| 270 | | | | | | |
| 360 | | | | | | |
| 480 | | | | | | |







Ordering codes and packing units (lead spacing 27.5 mm)

| $C_R^{1)}$ | Max. dimensions | Ordering code | I _{RMS,max} ²⁾ | ESR _{typ} | ESL _{typ} ³⁾ | tan δ | tan δ | Un- |
|------------|---|---------------------------|------------------------------------|--------------------|----------------------------------|------------------|------------------|-------|
| | $w \times h \times l$ | (composition see | 70 °C | 70 °C | 70 °C | | | taped |
| | | below) | 10 kHz | 10 kHz | 10 kHz | 1 kHz | 10 kHz | pcs./ |
| μF | mm | | Α | $m\Omega$ | nH | 10 ⁻³ | 10 ⁻³ | MOQ |
| $V_{R,70}$ | $_{\rm C} = 450 \text{ V DC}, V_{\rm op,85}$ | _{°C} = 450 V DC | | | | | | |
| 5.0 | $11.0 \times 21.0 \times 31.5$ | B32774D4505+000 | 5.0 | 21.1 | 19.0 | 1.2 | 10.7 | 2352 |
| 10.0 | $15.0 \times 24.5 \times 31.5$ | B32774D4106+000 | 8.0 | 10.9 | 24.0 | 1.2 | 11.0 | 1680 |
| 22.0 | $22.0 \times 36.5 \times 31.5$ | B32774D4226+000 | 14.5 | 5.4 | 30.0 | 1.3 | 12.1 | 784 |
| $V_{R,70}$ | _{°C} = 800 V DC, V _{op,85} | _{°C} = 700 V DC | | | | | | |
| 3.0 | $11.0 \times 21.0 \times 31.5$ | B32774D8305+000 | 4.5 | 24.8 | 19.0 | 0.9 | 7.6 | 2352 |
| 5.0 | $14.0 \times 24.5 \times 31.5$ | B32774D8505+000 | 6.5 | 15.3 | 23.0 | 0.9 | 7.7 | 1848 |
| 12.0 | $22.0 \times 36.5 \times 31.5$ | B32774D8126+000 | 13.0 | 6.8 | 34.0 | 1.0 | 8.3 | 784 |
| $V_{R,70}$ | $_{\rm C}$ = 1100 V DC, $V_{\rm op,85}$ | _{°C} = 920 V DC | | | | | | |
| 2.0 | $12.5 \times 21.5 \times 31.5$ | B32774D0205+000 | 4.5 | 26.3 | 19.0 | 0.7 | 5.3 | 2100 |
| 3.3 | $18.0 \times 27.5 \times 31.5$ | B32774D0335+000 | 7.0 | 16.2 | 22.0 | 0.7 | 5.4 | 1428 |
| 5.0 | $19.0 \times 30.0 \times 31.5$ | B32774D0505+000 | 9.0 | 10.9 | 27.0 | 0.7 | 5.5 | 896 |
| 7.0 | $22.0 \times 36.5 \times 31.5$ | B32774D0705+000 | 12.0 | 8.1 | 30.0 | 0.7 | 5.8 | 784 |
| $V_{R,70}$ | _{°C} = 1300 V DC, V _{op,85} | _{°C} = 1100 V DC | | | | | | |
| 1.5 | $12.5 \times 21.5 \times 31.5$ | B32774D1155K000 | 4.4 | 31.3 | 20.0 | 0.6 | 4.8 | 2100 |
| 3.0 | $18.0 \times 27.5 \times 31.5$ | B32774D1305K000 | 7.0 | 16.0 | 24.0 | 0.6 | 4.9 | 1428 |
| 5.0 | $22.0\times36.5\times31.5$ | B32774D1505K000 | 10.5 | 9.8 | 33.0 | 0.7 | 5.1 | 784 |

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code: Packing code:

 $J = \pm 5\%$

 $K = \pm 10\%$

000 = untaped (lead length 6 - 1 mm)

¹⁾ Capacitance value measured at 1 kHz

²⁾ Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le$ 20 °C at $\Delta ESR_{typ} \le \pm 5\%$

³⁾ Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





MKP DC link - high density series - up to 480 μF

Ordering codes and packing units (lead spacing 37.5 mm)

| $C_R^{1)}$ | Max. dimensions | P ₁ | Ordering code | I _{RMS,max} ²⁾ | ESR _{typ} | ESL _{typ} 3) | $tan \ \delta$ | tan δ | Un- |
|-----------------------|---|--------------------------------|------------------|------------------------------------|--------------------|-----------------------|------------------|------------------|-------|
| | $w \times h \times l$ | | (composition see | 70 °C | 70 °C | 70 °C | | | taped |
| | | | below) | 10 kHz | 10 kHz | 10 kHz | 1 kHz | 10 kHz | pcs./ |
| μF | mm | mm | | Α | mΩ | nH | 10 ⁻³ | 10 ⁻³ | MOQ |
| $\overline{V_{R,70}}$ | °C = 450 V DC, V _{op} | ₈₅ ° _C = | 450 V DC | | | | | | |
| 12 | 24.0 × 15.0 × 41.5 | _ | B32776T4126K000 | 7.0 | 17.1 | 19.0 | 2.2 | 21.0 | 1040 |
| 16 | $24.0 \times 19.0 \times 41.5$ | _ | B32776T4166K000 | 8.0 | 13.0 | 18.0 | 2.3 | 21.2 | 780 |
| 30 | $20.0 \times 39.5 \times 41.5$ | 10.2 | B32776G4306+000 | 14.0 | 7.0 | 11.0 | 2.3 | 21.3 | 640 |
| 30 | $20.0 \times 39.5 \times 41.5$ | _ | B32776E4306+000 | 14.0 | 7.3 | 28.0 | 2.4 | 22.3 | 640 |
| 35 | $28.0 \times 37.0 \times 42.0$ | 10.2 | B32776G4356+000 | 16.5 | 6.0 | 10.0 | 2.3 | 21.4 | 440 |
| 35 | $28.0 \times 37.0 \times 42.0$ | _ | B32776E4356+000 | 16.0 | 6.4 | 24.0 | 2.4 | 22.6 | 440 |
| 40 | $28.0 \times 37.0 \times 42.0$ | 10.2 | B32776G4406+000 | 17.5 | 5.3 | 11.0 | 2.3 | 21.4 | 440 |
| 40 | $28.0 \times 37.0 \times 42.0$ | _ | B32776E4406+000 | 17.0 | 5.6 | 26.0 | 2.4 | 22.7 | 440 |
| 40 | $43.0 \times 22.0 \times 41.5$ | 20.3 | B32776T4406K000 | 17.0 | 5.2 | 13.0 | 2.3 | 21.2 | 280 |
| 50 | $28.0 \times 42.5 \times 41.5$ | 10.2 | B32776G4506+000 | 20.0 | 4.3 | 12.0 | 2.3 | 21.7 | 440 |
| 50 | $28.0 \times 42.5 \times 41.5$ | _ | B32776E4506+000 | 19.0 | 4.7 | 30.0 | 2.5 | 23.8 | 440 |
| 60 | $30.0 \times 45.0 \times 42.0$ | 20.3 | B32776G4606+000 | 23.5 | 3.6 | 14.0 | 2.4 | 22.3 | 400 |
| 60 | $30.0 \times 45.0 \times 42.0$ | _ | B32776E4606+000 | 22.0 | 4.0 | 32.0 | 2.5 | 24.2 | 400 |
| 65 | $33.0\times48.0\times42.0$ | 20.3 | B32776G4656+000 | 25.5 | 3.3 | 14.0 | 2.3 | 22.2 | 180 |
| $V_{R,70}$ | $_{\text{C}}$ = 575 V DC, V_{op} | ₈₅ ° _C = | 500 V DC | | | | | | |
| 8.5 | $24.0 \times 15.0 \times 41.5$ | _ | B32776T5855+000 | 6.5 | 19.9 | 19.0 | 1.9 | 17.2 | 1040 |
| 12 | $24.0 \times 19.0 \times 41.5$ | _ | B32776T5126K000 | 8.0 | 14.4 | 18.0 | 1.9 | 17.4 | 780 |
| 25 | $20.0 \times 39.5 \times 41.5$ | 10.2 | B32776G5256K000 | 14.0 | 7.0 | 12.0 | 1.9 | 17.5 | 640 |
| 25 | $20.0 \times 39.5 \times 41.5$ | _ | B32776E5256K000 | 13.5 | 7.4 | 28.0 | 2.0 | 18.3 | 640 |
| 27 | $43.0 \times 22.0 \times 41.5$ | 20.3 | B32776T5276K000 | 15.5 | 6.4 | 14.0 | 1.9 | 17.5 | 280 |
| 30 | $28.0 \times 37.0 \times 42.0$ | 10.2 | B32776G5306K000 | 16.5 | 5.8 | 11.0 | 1.9 | 17.6 | 440 |
| 30 | $28.0 \times 37.0 \times 42.0$ | _ | B32776E5306K000 | 16.5 | 6.1 | 26.0 | 2.0 | 18.5 | 440 |
| 35 | $28.0 \times 42.5 \times 41.5$ | 10.2 | B32776G5356+000 | 19.0 | 5.0 | 12.0 | 1.9 | 17.8 | 440 |
| 35 | $28.0 \times 42.5 \times 41.5$ | _ | B32776E5356+000 | 18.0 | 5.3 | 29.0 | 2.0 | 19.0 | 440 |
| 45 | $30.0 \times 45.0 \times 42.0$ | 20.3 | B32776G5456K000 | 22.0 | 4.0 | 13.0 | 1.9 | 17.9 | 400 |
| 45 | $30.0 \times 45.0 \times 42.0$ | _ | B32776E5456K000 | 21.0 | 4.4 | 32.0 | 2.1 | 19.7 | 400 |
| 50 | $33.0\times48.0\times42.0$ | 20.3 | B32776G5506K000 | 25.0 | 3.5 | 14.0 | 2.0 | 18.1 | 180 |

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

Packing code:

 $J = \pm 5\%$

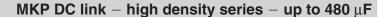
000 = untaped (lead length 6 - 1 mm)

 $K = \pm 10\%$

- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \leq \!\! 20$ °C at $\Delta ESR_{typ} \leq \! \pm \! 5\%$
- 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)

¹⁾ Capacitance value measured at 1 kHz







Ordering codes and packing units (lead spacing 37.5 mm)

| $\overline{C_R^{1)}}$ | Max. dimensions | P ₁ | Ordering code | I _{RMS,max} ²⁾ | ESR _{typ} | ESL _{typ} 3) | $tan \ \delta$ | tan δ | Un- |
|-----------------------|---|--------------------------------|------------------|------------------------------------|--------------------|-----------------------|------------------|------------------|-------|
| | $w \times h \times l$ | | (composition see | 70 °C | 70 °C | 70 °C | | | taped |
| | | | below) | 10 kHz | 10 kHz | 10 kHz | 1 kHz | 10 kHz | pcs./ |
| μF | mm | mm | | Α | mΩ | nH | 10 ⁻³ | 10 ⁻³ | MOQ |
| $V_{R,70}$ | °C = 800 V DC, V _{op} | ₈₅ ° _C = | 700 V DC | | | | | | |
| 6.8 | 24.0 × 15.0 × 41.5 | _ | B32776T8685+000 | 6.0 | 22.1 | 18.0 | 1.7 | 15.1 | 1040 |
| 8.5 | 24.0 × 19.0 × 41.5 | _ | B32776T8855+000 | 7.5 | 17.8 | 18.0 | 1.7 | 15.1 | 780 |
| 14 | $18.0 \times 32.5 \times 41.5$ | _ | B32776E8146+000 | 10.0 | 11.5 | 23.0 | 1.8 | 16.3 | 720 |
| 15 | $20.0 \times 39.5 \times 41.5$ | 10.2 | B32776G8156+000 | 12.0 | 9.6 | 10.0 | 1.7 | 15.2 | 640 |
| 15 | $20.0 \times 39.5 \times 41.5$ | _ | B32776E8156+000 | 11.5 | 10.3 | 24.0 | 1.7 | 15.7 | 640 |
| 20 | $28.0 \times 37.0 \times 42.0$ | 10.2 | B32776G8206+000 | 14.5 | 7.5 | 10.0 | 1.7 | 15.3 | 440 |
| 20 | $28.0 \times 37.0 \times 42.0$ | _ | B32776E8206+000 | 14.5 | 7.8 | 24.0 | 1.7 | 15.9 | 440 |
| 20 | $43.0 \times 22.0 \times 41.5$ | 20.3 | B32776T8206K000 | 14.5 | 7.2 | 14.0 | 1.7 | 15.1 | 280 |
| 22 | $28.0 \times 37.0 \times 42.0$ | 10.2 | B32776G8226+000 | 15.5 | 6.8 | 11.0 | 1.7 | 15.3 | 440 |
| 22 | $28.0 \times 37.0 \times 42.0$ | _ | B32776E8226+000 | 15.0 | 7.1 | 25.0 | 1.7 | 16.0 | 440 |
| 25 | $28.0 \times 42.5 \times 41.5$ | 10.2 | B32776G8256+000 | 17.0 | 6.1 | 11.0 | 1.7 | 15.4 | 440 |
| 25 | $28.0 \times 42.5 \times 41.5$ | _ | B32776E8256+000 | 16.5 | 6.4 | 28.0 | 1.8 | 16.3 | 440 |
| 30 | $30.0 \times 45.0 \times 42.0$ | 20.3 | B32776G8306+000 | 19.5 | 5.1 | 12.0 | 1.7 | 15.6 | 400 |
| 30 | $30.0 \times 45.0 \times 42.0$ | _ | B32776E8306+000 | 19.0 | 5.5 | 30.0 | 1.8 | 16.7 | 400 |
| 35 | $33.0 \times 48.0 \times 42.0$ | 20.3 | B32776G8356+000 | 22.0 | 4.3 | 14.0 | 1.7 | 15.7 | 180 |
| $V_{R,70}$ | $_{\text{C}}$ = 900 V DC, V_{op} | ₈₅ ° _C = | 800 V DC | | | | | | |
| 5 | $24.0 \times 15.0 \times 41.5$ | _ | B32776T9505+000 | 5.5 | 26.1 | 19.0 | 1.5 | 13.4 | 1040 |
| 7.5 | $24.0 \times 19.0 \times 41.5$ | _ | B32776T9755K000 | 7.5 | 17.8 | 18.0 | 1.5 | 13.5 | 780 |
| 15 | $20.0 \times 39.5 \times 41.5$ | 10.2 | B32776G9156K000 | 12.5 | 9.1 | 12.0 | 1.5 | 13.6 | 640 |
| 15 | $20.0 \times 39.5 \times 41.5$ | _ | B32776E9156K000 | 12.0 | 9.4 | 28.0 | 1.5 | 14.1 | 640 |
| 16 | $43.0 \times 22.0 \times 41.5$ | 20.3 | B32776T9166K000 | 14.0 | 8.1 | 14.0 | 1.5 | 13.5 | 280 |
| 20 | $28.0 \times 37.0 \times 42.0$ | 10.2 | B32776G9206K000 | 15.0 | 7.0 | 11.0 | 1.5 | 13.6 | 440 |
| 20 | $28.0 \times 37.0 \times 42.0$ | _ | B32776E9206K000 | 15.0 | 7.3 | 26.0 | 1.6 | 14.2 | 440 |
| 22 | $28.0 \times 42.5 \times 41.5$ | 10.2 | B32776G9226K000 | 17.0 | 6.3 | 12.0 | 1.5 | 13.7 | 440 |
| 22 | $28.0 \times 42.5 \times 41.5$ | _ | B32776E9226K000 | 16.5 | 6.6 | 29.0 | 1.6 | 14.5 | 440 |
| 25 | $30.0 \times 45.0 \times 42.0$ | 20.3 | B32776G9256+000 | 19.0 | 5.5 | 13.0 | 1.5 | 13.8 | 400 |
| 25 | $30.0 \times 45.0 \times 42.0$ | _ | B32776E9256+000 | 18.5 | 5.9 | 32.0 | 1.6 | 14.7 | 400 |
| 30 | $33.0\times48.0\times42.0$ | 20.3 | B32776G9306+000 | 21.5 | 4.7 | 14.0 | 1.5 | 13.9 | 180 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

Packing code:

 $J = \pm 5\%$ $K = \pm 10\%$ 000 = untaped (lead length 6 - 1 mm)

- 1) Capacitance value measured at 1 kHz
- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le$ 20 °C at $\Delta ESR_{typ} \le \pm 5\%$
- 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





MKP DC link - high density series - up to 480 μF

Ordering codes and packing units (lead spacing 37.5 mm)

| $\overline{C_R^{1)}}$ | Max. dimensions | P ₁ | Ordering code | I _{RMS,max} ²⁾ | ESR _{typ} | ESL _{typ} ³⁾ | tan δ | tan δ | Un- |
|-----------------------|---|--------------------------------|------------------|------------------------------------|--------------------|----------------------------------|------------------|------------------|-------|
| | $w \times h \times I$ | | (composition see | 70 °C | 70 °C | 70 °C | | | taped |
| | | | below) | 10 kHz | 10 kHz | 10 kHz | 1 kHz | 10 kHz | pcs./ |
| μF | mm | mm | , | Α | mΩ | nH | 10 ⁻³ | 10 ⁻³ | MOQ |
| $V_{R,70}$ | _C = 1100 V DC, V _{op} | ₈₅ ° _C = | 920 V DC | | | | | | |
| 3.9 | $24.0 \times 15.0 \times 41.5$ | _ | B32776T0395+000 | 5.0 | 30.5 | 18.0 | 1.4 | 12.1 | 1040 |
| 5 | $24.0 \times 19.0 \times 41.5$ | _ | B32776T0505+000 | 6.5 | 23.6 | 18.0 | 1.4 | 12.1 | 780 |
| 12 | $20.0 \times 39.5 \times 41.5$ | 10.2 | B32776G0126+000 | 12.0 | 10.2 | 12.0 | 1.4 | 12.2 | 640 |
| 12 | $20.0 \times 39.5 \times 41.5$ | _ | B32776E0126+000 | 11.5 | 10.5 | 28.0 | 1.4 | 12.6 | 640 |
| 13 | $43.0 \times 22.0 \times 41.5$ | 20.3 | B32776T0136K000 | 13.0 | 8.9 | 14.0 | 1.4 | 12.1 | 280 |
| 14 | $28.0 \times 37.0 \times 42.0$ | 10.2 | B32776G0146+000 | 13.5 | 8.7 | 21.0 | 1.4 | 12.2 | 440 |
| 14 | $28.0 \times 37.0 \times 42.0$ | _ | B32776E0146+000 | 13.5 | 9.0 | 25.0 | 1.4 | 12.6 | 440 |
| 16 | $28.0 \times 42.5 \times 41.5$ | 10.2 | B32776G0166+000 | 15.5 | 7.4 | 12.0 | 1.4 | 12.3 | 440 |
| 16 | $28.0 \times 42.5 \times 41.5$ | _ | B32776E0166+000 | 15.0 | 7.8 | 30.0 | 1.4 | 12.9 | 440 |
| 20 | $30.0 \times 45.0 \times 42.0$ | 20.3 | B32776G0206+000 | 18.0 | 6.0 | 14.0 | 1.4 | 12.4 | 400 |
| 20 | $30.0 \times 45.0 \times 42.0$ | _ | B32776E0206+000 | 17.5 | 6.5 | 32.0 | 1.4 | 13.1 | 400 |
| 22 | $33.0\times48.0\times42.0$ | 20.3 | B32776G0226+000 | 21.0 | 4.9 | 15.0 | 1.3 | 11.4 | 180 |
| $V_{R,70}$ | °C = 1300 V DC, V _{op} | ₈₅ ° _C = | 1100 V DC | | | | | | |
| 2.7 | $24.0 \times 15.0 \times 41.5$ | _ | B32776T1275+000 | 5.0 | 34.7 | 19.0 | 1.1 | 9.6 | 1040 |
| 3.5 | $24.0 \times 19.0 \times 41.5$ | _ | B32776T1355+000 | 6.0 | 27.4 | 18.0 | 1.1 | 9.7 | 780 |
| 8.0 | $20.0 \times 39.5 \times 41.5$ | 10.2 | B32776G1805+000 | 11.0 | 12.1 | 12.0 | 1.1 | 9.7 | 640 |
| 8.0 | $20.0 \times 39.5 \times 41.5$ | _ | B32776E1805+000 | 10.5 | 12.4 | 24.0 | 1.2 | 10.0 | 640 |
| 9.0 | $43.0 \times 22.0 \times 41.5$ | 20.3 | B32776T1905K000 | 12.0 | 10.7 | 13.0 | 1.1 | 9.7 | 280 |
| 10 | $28.0 \times 37.0 \times 42.0$ | 10.2 | B32776G1106+000 | 13.0 | 9.6 | 11.0 | 1.1 | 9.7 | 440 |
| 10 | $28.0 \times 37.0 \times 42.0$ | _ | B32776E1106+000 | 12.5 | 9.9 | 26.0 | 1.2 | 10.0 | 440 |
| 12 | $28.0 \times 42.5 \times 41.5$ | 10.2 | B32776G1126+000 | 14.5 | 8.1 | 12.0 | 1.1 | 9.8 | 440 |
| 12 | $28.0 \times 42.5 \times 41.5$ | _ | B32776E1126+000 | 14.0 | 8.5 | 28.0 | 1.2 | 10.1 | 440 |
| 14 | $30.0 \times 45.0 \times 42.0$ | 20.3 | B32776G1146+000 | 17.0 | 6.8 | 14.0 | 1.1 | 10.1 | 400 |
| 14 | $30.0 \times 45.0 \times 42.0$ | _ | B32776E1146+000 | 16.5 | 7.3 | 32.0 | 1.2 | 10.4 | 400 |
| 16 | $33.0\times48.0\times42.0$ | 20.3 | B32776G1166+000 | 19.0 | 6.0 | 15.0 | 1.1 | 9.9 | 180 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$

K = ±10%

Packing code:

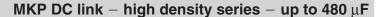
000 = untaped (lead length 6 - 1 mm)

¹⁾ Capacitance value measured at 1 kHz

²⁾ Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \leq \!\! 20$ °C at $\Delta ESR_{typ} \leq \! \pm 5\%$

³⁾ Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)







Ordering codes and packing units (lead spacing 52.5 mm, $P_1 = 20.3$ mm)

| $C_R^{1)}$ | Max. dimensions | Ordering code | I _{RMS,max} ²⁾ | ESR _{typ} | ESL _{typ} ³⁾ | tan δ | tan δ | Un- |
|-------------------|--|--------------------------|------------------------------------|--------------------|----------------------------------|------------------|--------------|-------|
| | $w \times h \times I$ | (composition see | 70 °C | 70 °C | 70 °C | | | taped |
| | | below) | 10 kHz | 10 kHz | 10 kHz | 1 kHz | 10 kHz | pcs./ |
| μF | mm | | Α | mΩ | nH | 10 ⁻³ | 10-3 | MOQ |
| V _{R,70} | $_{\rm C} = 450 \text{ V DC}, V_{\rm op,85}$ | _{°C} = 450 V DC | | | | | | |
| 55 | $43.0 \times 24.0 \times 57.5$ | B32778T4556K000 | 16.5 | 7.2 | 13.0 | 4.3 | 41.7 | 560 |
| 75 | $30.0 \times 45.0 \times 57.5$ | B32778G4756+000 | 21.0 | 5.6 | 12.0 | 4.4 | 42.6 | 280 |
| 80 | $30.0 \times 45.0 \times 57.5$ | B32778G4806+000 | 21.5 | 5.3 | 13.0 | 4.4 | 42.7 | 280 |
| 100 | $35.0 \times 50.0 \times 57.5$ | B32778G4107+000 | 26.0 | 4.3 | 14.0 | 4.5 | 43.3 | 108 |
| 110 | $35.0 \times 50.0 \times 57.5$ | B32778G4117K000 | 27.0 | 3.9 | 15.0 | 4.5 | 43.6 | 108 |
| 150 | $130.0 \times 24.0 \times 57.5$ | B32778J4157K000 | 43.5 | 2.7 | 4.0 | 4.4 | 42.1 | 80 |
| 170 | $45.0 \times 57.0 \times 57.5$ | B32778G4177+000 | 36.5 | 2.6 | 17.0 | 4.6 | 45.7 | 140 |
| 180 | $60.0 \times 45.0 \times 57.5$ | B32778G4187+000 | 39.0 | 2.5 | 19.0 | 4.6 | 44.6 | 200 |
| 480 | $130.0 \times 58.0 \times 57.5$ | B32778J4487K000 | 79.5 | 0.9 | 6.0 | 4.8 | 45.4 | 40 |
| V _{R,70} | _C = 575 V DC, V _{op,85} | _{°C} = 500 V DC | | | | | | |
| 40 | $43.0 \times 24.0 \times 57.5$ | B32778T5406K000 | 15.5 | 8.5 | 13.0 | 3.6 | 34.5 | 560 |
| 60 | $30.0 \times 45.0 \times 57.5$ | B32778G5606+000 | 20.5 | 5.8 | 13.0 | 3.7 | 35.3 | 280 |
| 80 | $35.0 \times 50.0 \times 57.5$ | B32778G5806+000 | 25.5 | 4.4 | 15.0 | 3.7 | 36.0 | 108 |
| 110 | $130.0 \times 24.0 \times 57.5$ | B32778J5117K000 | 40.5 | 3.0 | 5.0 | 3.6 | 34.5 | 80 |
| 120 | $45.0 \times 57.0 \times 57.5$ | B32778G5127+000 | 34.5 | 3.1 | 17.0 | 3.8 | 37.2 | 140 |
| 130 | $60.0 \times 45.0 \times 57.5$ | B32778G5137+000 | 36.5 | 2.8 | 19.0 | 3.8 | 36.7 | 200 |
| 360 | $130.0 \times 58.0 \times 57.5$ | B32778J5367K000 | 75.0 | 1.0 | 6.0 | 4.0 | 37.3 | 40 |
| V _{R,70} | _{°C} = 800 V DC, V _{op,85} | _{°C} = 700 V DC | | | | | | |
| 30 | $43.0 \times 24.0 \times 57.5$ | B32778T8306K000 | 14.5 | 9.8 | 14.0 | 3.2 | 30.2 | 560 |
| 45 | $30.0 \times 45.0 \times 57.5$ | B32778G8456+000 | 19.5 | 6.6 | 14.0 | 3.2 | 30.9 | 280 |
| 50 | $30.0 \times 45.0 \times 57.5$ | B32778G8506+000 | 20.0 | 6.3 | 13.0 | 3.2 | 30.9 | 280 |
| 55 | $35.0 \times 50.0 \times 57.5$ | B32778G8556+000 | 23.0 | 5.6 | 14.0 | 3.2 | 31.1 | 108 |
| 60 | $35.0 \times 50.0 \times 57.5$ | B32778G8606+000 | 23.5 | 5.1 | 15.0 | 3.3 | 31.2 | 108 |
| 80 | $130.0 \times 24.0 \times 57.5$ | B32778J8806K000 | 37.5 | 3.6 | 4.0 | 3.2 | 30.2 | 80 |
| 90 | $45.0 \times 57.0 \times 57.5$ | B32778G8906+000 | 32.5 | 3.5 | 17.0 | 3.3 | 32.2 | 140 |
| 100 | $60.0 \times 45.0 \times 57.5$ | B32778G8107+000 | 34.5 | 3.2 | 19.0 | 3.3 | 31.9 | 200 |
| 270 | $130.0 \times 58.0 \times 57.5$ | B32778J8277K000 | 70.5 | 1.2 | 6.0 | 3.5 | 32.4 | 40 |

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

Packing code:

 $J = \pm 5\%$

000 = untaped (lead length 6 - 1 mm)

 $K = \pm 10\%$

- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le \!\! 20$ °C at $\Delta ESR_{typ} \le \! \pm \!\! 5\%$
- 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)

¹⁾ Capacitance value measured at 1 kHz





MKP DC link - high density series - up to 480 μF

Ordering codes and packing units (lead spacing 52.5 mm, $P_1 = 20.3$ mm)

| $C_R^{1)}$ | Max. dimensions | Ordering code | I _{RMS,max} ²⁾ | ESR _{typ} | ESL _{typ} ³⁾ | tan δ | tan δ | Un- |
|-------------------|--|----------------------------|------------------------------------|--------------------|----------------------------------|------------------|------------------|-------|
| | $w \times h \times l$ | (composition see | 70 °C | 70 °C | 70 °C | | | taped |
| | | below) | 10 kHz | 10 kHz | 10 kHz | 1 kHz | 10 kHz | pcs./ |
| μF | mm | , | Α | $m\Omega$ | nH | 10 ⁻³ | 10 ⁻³ | MOQ |
| V _{R,70} | _{CC} = 900 V DC, V _{op,85} | °c = 800 V DC | | | | | | |
| 25 | $43.0 \times 24.0 \times 57.5$ | B32778T9256K000 | 13.5 | 10.7 | 13.0 | 2.8 | 26.8 | 560 |
| 35 | $30.0 \times 45.0 \times 57.5$ | B32778G9356+000 | 18.0 | 7.7 | 13.0 | 2.9 | 27.3 | 280 |
| 50 | $35.0 \times 50.0 \times 57.5$ | B32778G9506K000 | 22.5 | 5.6 | 15.0 | 2.9 | 27.7 | 108 |
| 70 | $45.0 \times 57.0 \times 57.5$ | B32778G9706+000 | 31.0 | 3.8 | 18.0 | 3.0 | 28.5 | 140 |
| 70 | $130.0 \times 24.0 \times 57.5$ | B32778J9706K000 | 36.0 | 3.8 | 4.0 | 2.9 | 27.2 | 80 |
| 75 | $60.0 \times 45.0 \times 57.5$ | B32778G9756+000 | 32.5 | 3.6 | 20.0 | 2.9 | 28.2 | 200 |
| 210 | $130.0 \times 58.0 \times 57.5$ | B32778J9217K000 | 66.0 | 1.3 | 6.0 | 3.1 | 28.6 | 40 |
| V _{R,70} | $_{\rm C}$ = 1100 V DC, $V_{\rm op,85}$ | °c = 920 V DC | | | | | | |
| 20 | $43.0 \times 24.0 \times 57.5$ | B32778T0206K000 | 13.0 | 11.9 | 13.0 | 2.6 | 24.1 | 560 |
| 30 | $30.0 \times 45.0 \times 57.5$ | B32778G0306+000 | 17.5 | 8.2 | 13.0 | 2.6 | 24.5 | 280 |
| 40 | $35.0 \times 50.0 \times 57.5$ | B32778G0406+000 | 21.5 | 6.2 | 15.0 | 2.7 | 25.9 | 108 |
| 58 | $45.0 \times 57.0 \times 57.5$ | B32778G0586+000 | 29.0 | 4.3 | 17.0 | 2.7 | 25.4 | 140 |
| 60 | $60.0 \times 45.0 \times 57.5$ | B32778G0606+000 | 30.5 | 4.0 | 19.0 | 2.7 | 25.2 | 200 |
| 60 | $130.0 \times 24.0 \times 57.5$ | B32778J0606K000 | 34.5 | 4.1 | 4.0 | 2.7 | 25.1 | 80 |
| 200 | $130.0 \times 58.0 \times 57.5$ | B32778J0207K000 | 66.0 | 1.4 | 6.0 | 3.0 | 26.8 | 40 |
| V _{R,70} | $_{\rm C}$ = 1300 V DC, $V_{\rm op,85}$ | _{5°C} = 1100 V DC | | | | | | |
| 14 | $43.0 \times 24.0 \times 57.5$ | B32778T1146K000 | 12.0 | 13.8 | 13.0 | 2.1 | 19.5 | 560 |
| 20 | $30.0 \times 45.0 \times 57.5$ | B32778G1206+000 | 16.0 | 9.7 | 13.0 | 2.1 | 19.8 | 280 |
| 25 | $35.0 \times 50.0 \times 57.5$ | B32778G1256+000 | 19.0 | 7.8 | 15.0 | 2.1 | 19.9 | 108 |
| 27 | $35.0 \times 50.0 \times 57.5$ | B32778G1276+000 | 19.5 | 7.3 | 15.0 | 2.1 | 20.0 | 108 |
| 38 | $130.0 \times 24.0 \times 57.5$ | B32778J1386K000 | 31.5 | 5.1 | 4.0 | 2.1 | 19.5 | 80 |
| 40 | $45.0 \times 57.0 \times 57.5$ | B32778G1406+000 | 26.5 | 5.0 | 17.0 | 2.2 | 20.3 | 140 |
| 42 | $60.0 \times 45.0 \times 57.5$ | B32778G1426+000 | 28.0 | 4.7 | 19.0 | 2.2 | 20.2 | 200 |
| 120 | $130.0 \times 58.0 \times 57.5$ | B32778J1127K000 | 58.5 | 1.7 | 6.0 | 2.3 | 20.5 | 40 |
| | · | | | | | | | _ |

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$

 $K = \pm 10\%$

Packing code:

000 = untaped (lead length 6 - 1 mm)

¹⁾ Capacitance value measured at 1 kHz

²⁾ Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le \! 20$ °C at $\Delta ESR_{typ} \le \! \pm \! 5\%$

³⁾ Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





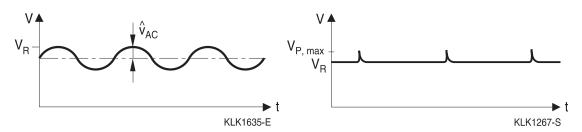


Technical data

Reference standard: IEC 61071:2007. All data given at T = 20 °C, unless otherwise specified.

| Reference standard. IEC 61071.2007. At | i uala give | z_{11} at $1=2$ | 20 C, uili | ess officin | wise spec | illeu. | | |
|--|---|-------------------|------------|---------------|-----------|--------|--|--|
| Operating temperature range (case) | Max. ope | 05 °C | | | | | | |
| | Upper category temperature T _{max} +105 | | | | | | | |
| | Lower ca | ategory te | mperature | $\in T_{min}$ | -4 | 40 °C | | |
| Insulation resistance R _{ins} | τ > 10 000 s (after 1 min.) | | | | | | | |
| given as time constant | For V _B ≥ 500 V measured at 500 V | | | | | | | |
| $\tau = C_R \cdot R_{ins}$, rel. humidity $\leq 65\%$ | For V _B < 500 V measured at V _B | | | | | | | |
| (minimum as-delivered values) | | | | | | | | |
| DC test voltage between terminals (10 s) | 1.5 · V _R | | | | | | | |
| Voltage test terminal to case (10 s) | 2110 V AC, 50 Hz | | | | | | | |
| Pulse Handling Capability (V/µs) | I _P (A) / C (μF) | | | | | | | |
| Reliability: Failure rate λ | 10 fit (≤ 1 · 10 ⁻⁹ /h) at 0.5 · V _R , 40 °C | | | | | | | |
| | For conversion to other operating conditions and | | | | | | | |
| | temperatures, refer to chapter "Quality, 2 Reliability". | | | | | | | |
| Service life t_{SL} | 100 000 h at V _R and 70 °C | | | | | | | |
| V _R (V DC) | 450 | 575 | 800 | 900 | 1100 | 1300 | | |
| Continuous operation voltage | | | | | | | | |
| V _{op} (V DC) at 70 °C | 450 | 575 | 800 | 900 | 1100 | 1300 | | |
| Continuous operation voltage | | | | | | | | |
| V _{op} (V DC) at 85 °C | 450 | 500 | 700 | 800 | 920 | 1100 | | |
| For temperatures between 85 °C and 105 °C | 1.33%/°C of V _{op} derating compared to V _{op} at 85 °C | | | | | | | |

Typical waveforms



Restrictions:

 \mathbf{V}_{R} : Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.





MKP DC link – high density series up to 480 μ F

 $\hat{v}_{AC} \leq 0.2 \cdot V_{R}$

| Overvoltage | Maximum duration within one day | Observation | | |
|-----------------------|---------------------------------|-------------------|--|--|
| 1.1 · V _R | 30% of on-load duration | System regulation | | |
| 1.15 · V _R | 30 min. | System regulation | | |
| $1.2 \cdot V_R$ | 5 min. | System regulation | | |
| 1.3 · V _R | 1 min. | System regulation | | |

NOTE 1 An overvoltage equal to $1.5 \cdot V_R$ for 30 ms is permitted 1000 times during the life of the capacitor.

The amplitudes of the overvoltages that may be tolerated without significant reduction in the life time of the capacitor depend on their duration, the number of application and the capacitor temperature.

In addition these values assume that the overvoltages may appear when the internal temperature of the capacitor is less than 0 °C but within the temperature category.

NOTE 2 The average applied voltage must not be higher than the specified voltage.

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

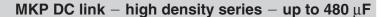
Note:

The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt values

| Lead spacing | 27.5 | mm | | | 37.5 mm | | | | | 52.5 mm | | | | | | |
|-----------------------|------|-----|------|------|---------|-----|-----|--------|------|---------|-----|-----|-----|-----|------|------|
| Туре | B32 | 774 | | | B32776 | | | B32778 | | | | | | | | |
| V _R (V DC) | 450 | 800 | 1100 | 1300 | 450 | 575 | 800 | 900 | 1100 | 1300 | 450 | 575 | 800 | 900 | 1100 | 1300 |
| dV/dt in V/μs | 30 | 40 | 75 | 100 | 21 | 22 | 22 | 35 | 54 | 73 | 14 | 14 | 15 | 22 | 35 | 50 |







Characteristics curves

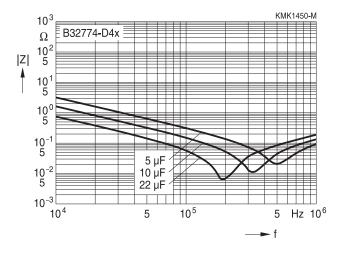
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

450 V DC

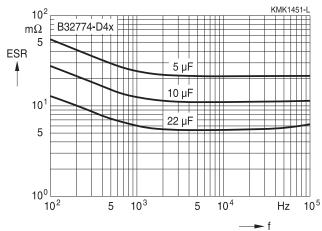


ESR versus frequency f

(typical values)

Lead spacing 27.5 mm

450 V DC

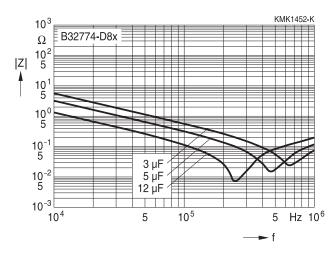


Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

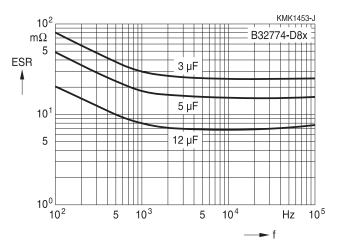
800 V DC



ESR versus frequency f

(typical values)

Lead spacing 27.5 mm







MKP DC link – high density series – up to 480 μ F

Characteristics curves

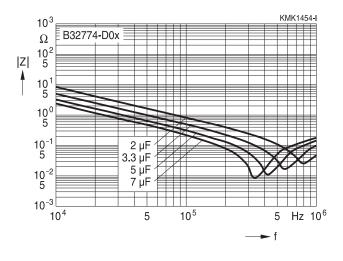
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

1100 V DC

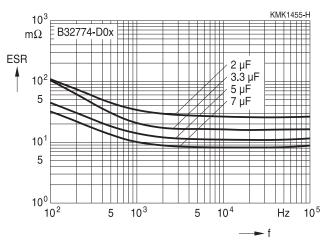


ESR versus frequency f

(typical values)

Lead spacing 27.5 mm

1100 V DC

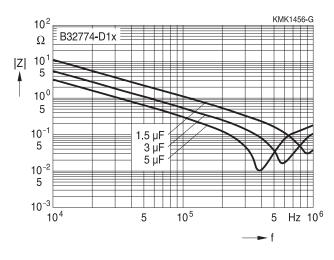


Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

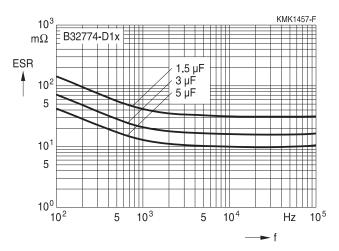
1300 V DC



ESR versus frequency f

(typical values)

Lead spacing 27.5 mm





MKP DC link - high density series - up to 480 μF



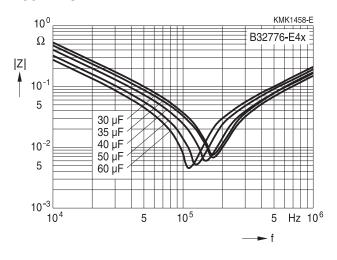
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

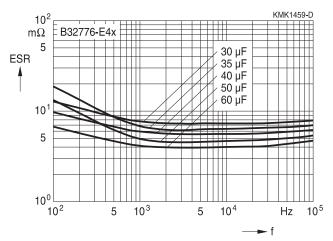
450 V DC



ESR versus frequency f (typical values)

Lead spacing 37.5 mm

450 V DC

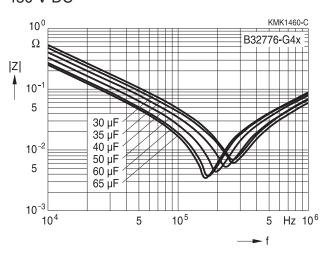


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

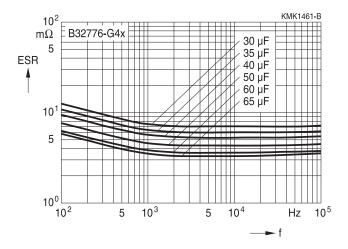
450 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm







MKP DC link - high density series - up to 480 μF

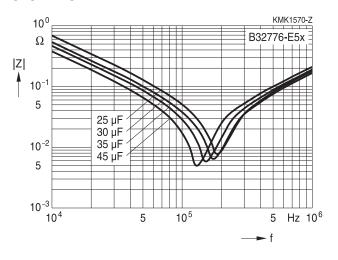
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

575 V DC

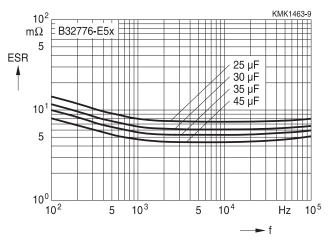


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

575 V DC

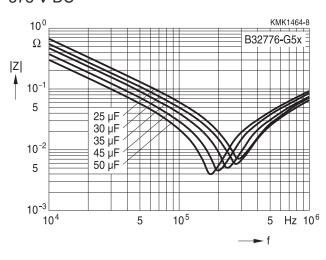


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

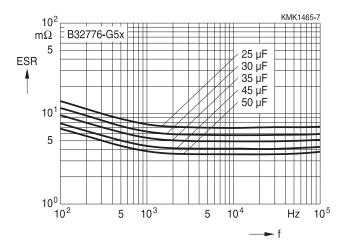
575 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm





MKP DC link – high density series – up to 480 μ F



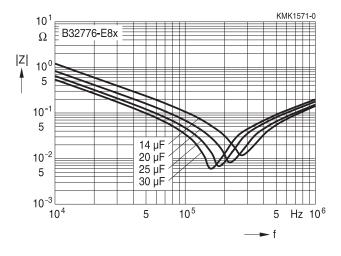
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

B32776E8*/800 V DC

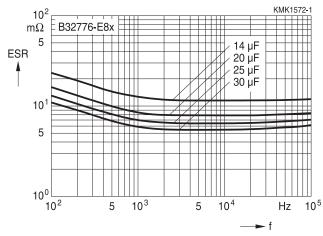


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

B32776E8*/800 V DC

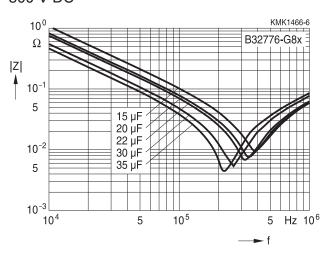


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

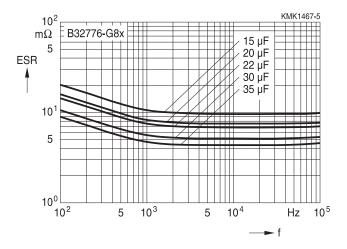
800 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm







MKP DC link - high density series - up to 480 μF

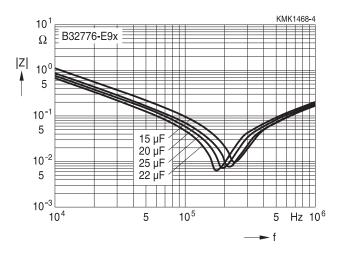
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

900 V DC

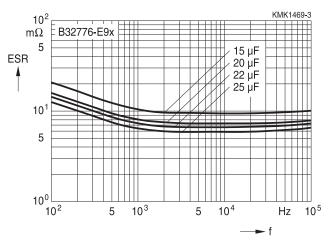


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

900 V DC

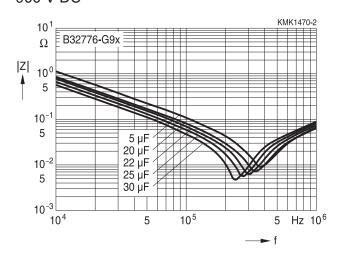


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

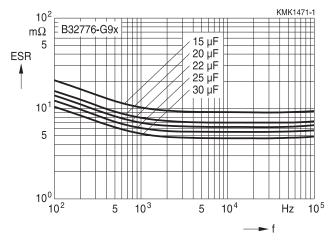
900 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm





MKP DC link - high density series - up to 480 μF



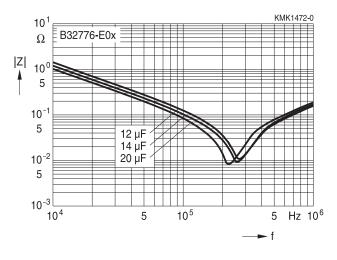
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

1100 V DC

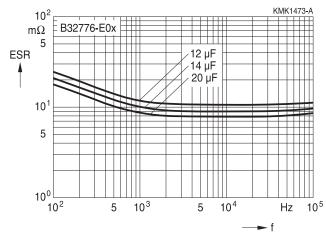


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

1100 V DC

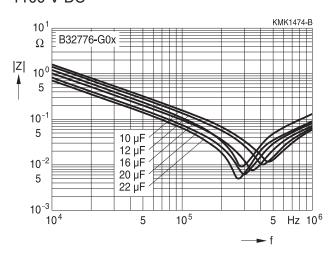


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

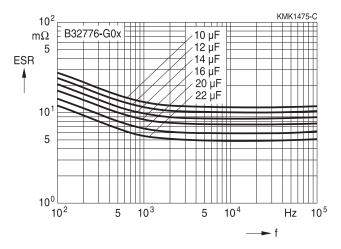
1100 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm







MKP DC link - high density series - up to 480 μF

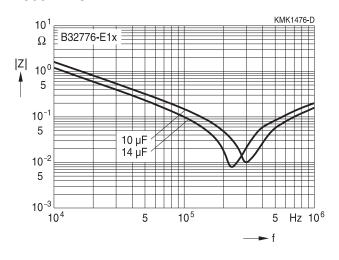
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

1300 V DC

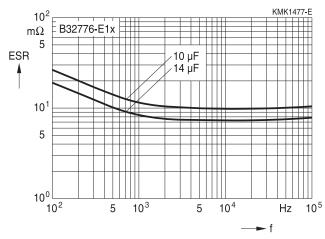


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

1300 V DC

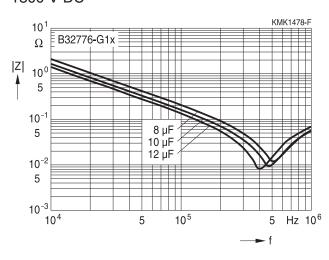


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

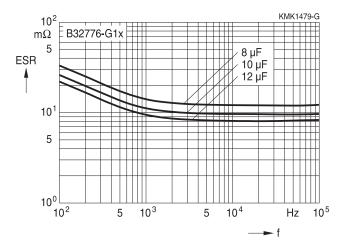
1300 V DC



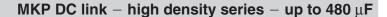
ESR versus frequency f

(typical values)

Lead spacing 37.5 mm





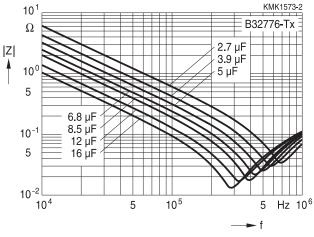




Characteristics curves

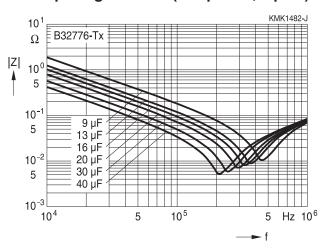
Impedance Z versus frequency f (typical values)

Lead spacing 37.5 mm (low profile, 2 pins)



Impedance Z versus frequency f (typical values)

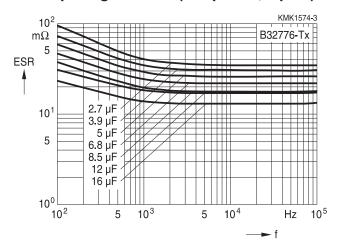
Lead spacing 37.5 mm (low profile, 4 pins)



ESR versus frequency f

(typical values)

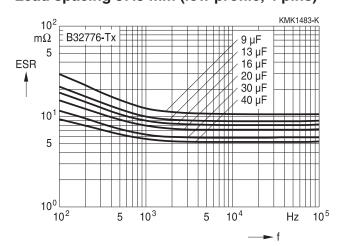
Lead spacing 37.5 mm (low profile, 2 pins)



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm (low profile, 4 pins)







MKP DC link - high density series - up to 480 μF

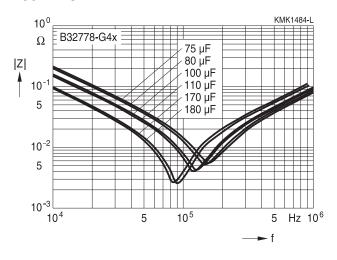
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

450 V DC

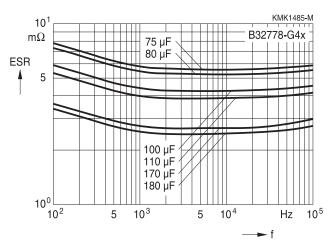


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

450 V DC

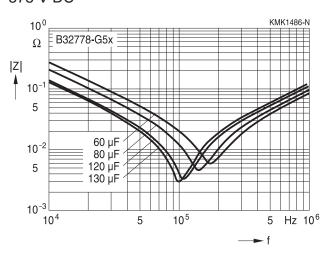


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

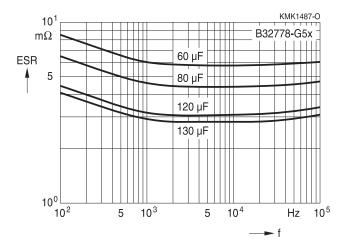
575 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm





MKP DC link - high density series - up to 480 μF



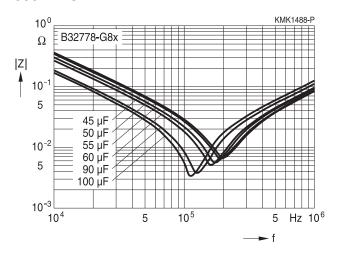
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

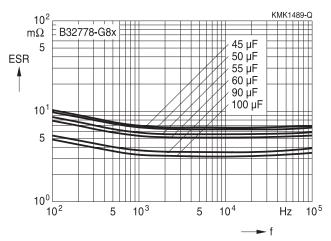
800 V DC



ESR versus frequency f (typical values)

Lead spacing 52.5 mm

800 V DC

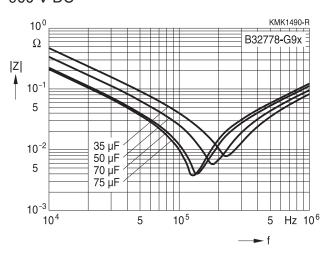


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

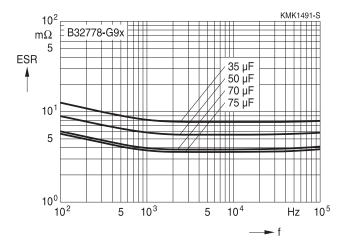
900 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm







MKP DC link – high density series – up to 480 μ F

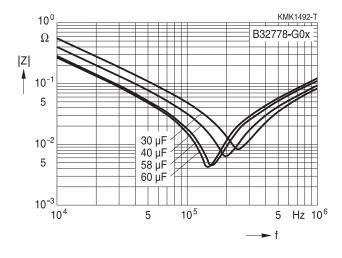
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

B32778G0*/1100 V DC

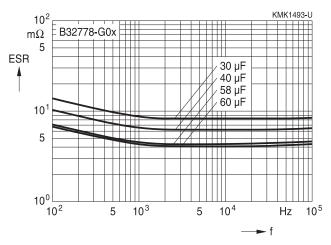


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

B32778G0*/1100 V DC

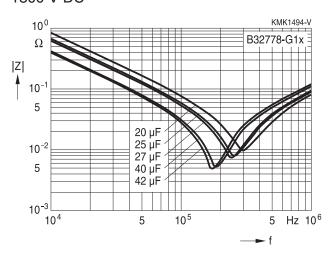


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

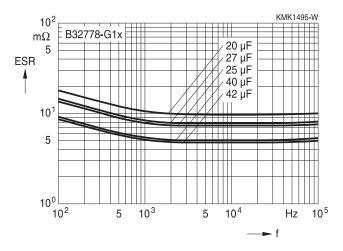
1300 V DC



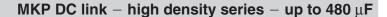
ESR versus frequency f

(typical values)

Lead spacing 52.5 mm





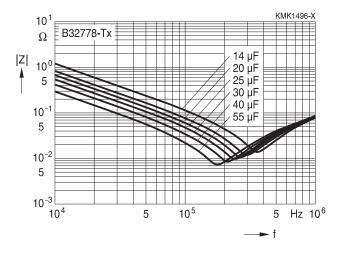




Characteristics curves

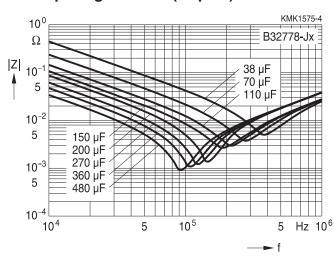
Impedance Z versus frequency f (typical values)

Lead spacing 52.5 mm (low profile)



Impedance Z versus frequency f (typical values)

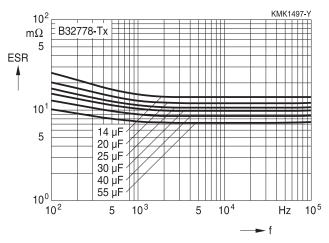
Lead spacing 52.5 mm (12 pins)



ESR versus frequency f

(typical values)

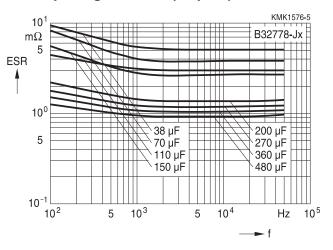
Lead spacing 52.5 mm (low profile)



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm (12 pins)







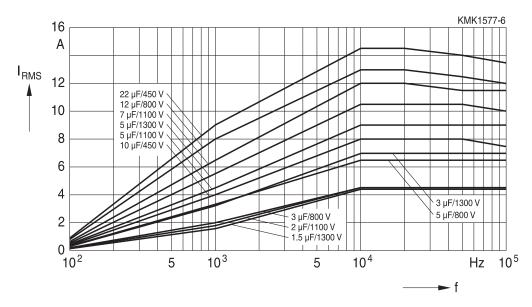
MKP DC link - high density series - up to 480 μF

Characteristics curves

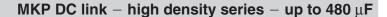
Permissible current I_{RMS} versus frequency f at 70 $^{\circ}$ C

Lead spacing 27.5 mm

B32774D*







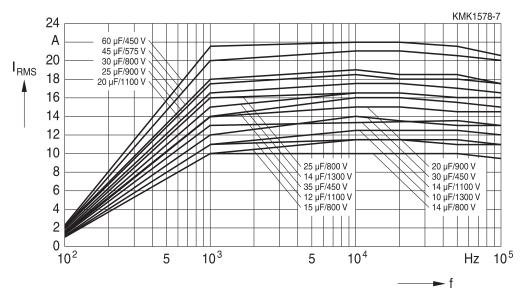


Characteristics curves

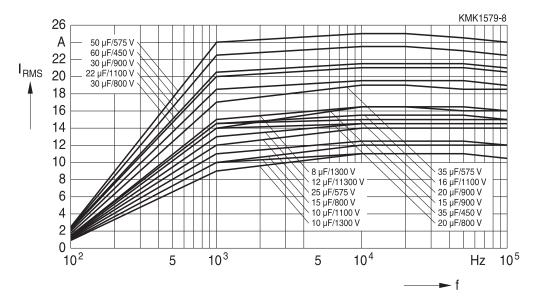
Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 37.5 mm

B32776E*



B32776G*







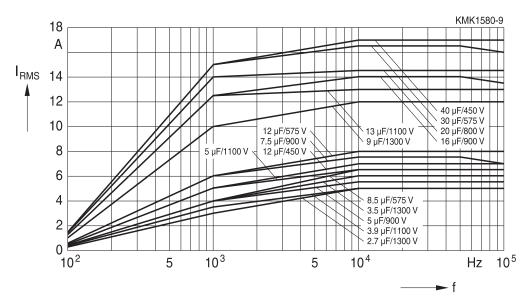
MKP DC link - high density series - up to 480 μF

Characteristics curves

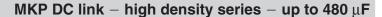
Permissible current I_{RMS} versus frequency f at 70 $^{\circ}$ C

Lead spacing 37.5 mm

B32776T*







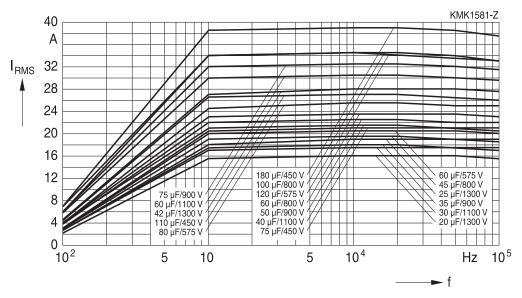


Characteristics curves

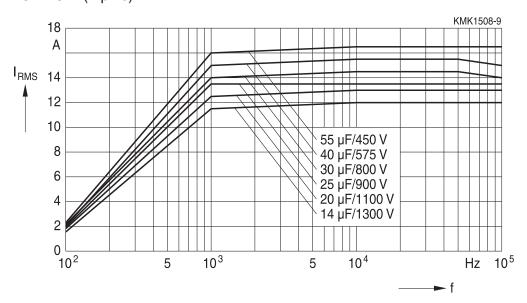
Permissible current I_{RMS} versus frequency f at 70 $^{\circ}$ C

Lead spacing 52.5 mm

B32778G* (4 pins)



B32778T* (4 pins)







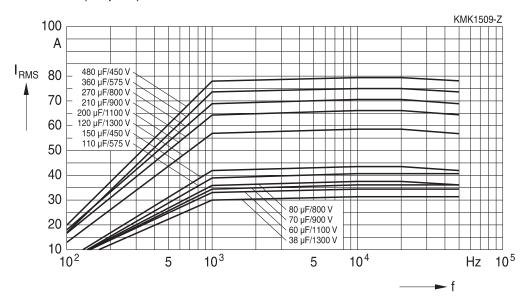
MKP DC link - high density series - up to 480 μF

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 $^{\circ}$ C

Lead spacing 52.5 mm

B32778J* (12 pins)

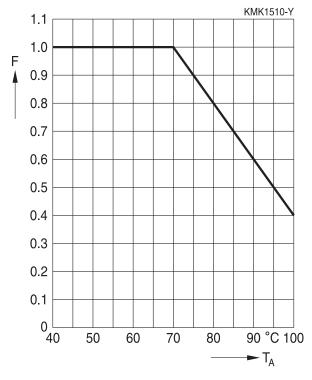






MKP DC link - high density series up to 480 μF

Curves characteristics (I_{RMS} derating versus temperature)



Maximum I_{RMS} current as function of the ambient temperature: I_{RMS} (T_A) = Factor \times I_{RMS} (70 °C)





MKP DC link – high density series up to 480 μ F

Heat transference for self heating calculation

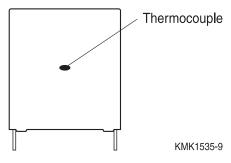


Figure 1

| Box dimen | sions | Equivalent heat | | | | | | |
|-----------|--------|-----------------|-------------|--|--|--|--|--|
| | | | coefficient | | | | | |
| w (mm) | h (mm) | I (mm) | G (mW/°C) | | | | | |
| 11.0 | 19.0 | 31.5 | 25 | | | | | |
| 11.0 | 21.0 | 31.5 | 28 | | | | | |
| 12.5 | 21.5 | 31.5 | 30 | | | | | |
| 13.5 | 23.0 | 31.5 | 32 | | | | | |
| 14.0 | 24.5 | 31.5 | 35 | | | | | |
| 15.0 | 24.5 | 31.5 | 36 | | | | | |
| 16.0 | 32.0 | 31.5 | 45 | | | | | |
| 18.0 | 27.5 | 31.5 | 44 | | | | | |
| 18.0 | 33.0 | 31.5 | 48 | | | | | |
| 19.0 | 30.0 | 31.5 | 48 | | | | | |
| 20.0 | 11.0 | 31.5 | 65 | | | | | |
| 21.0 | 31.0 | 31.5 | 51 | | | | | |
| 22.0 | 36.5 | 31.5 | 58 | | | | | |
| 12.0 | 22.0 | 41.5 | 70 | | | | | |
| 14.0 | 25.0 | 41.5 | 43 | | | | | |
| 16.0 | 28.5 | 41.5 | 50 | | | | | |
| 18.0 | 32.5 | 41.5 | 59 | | | | | |
| 20.0 | 39.5 | 41.5 | 72 | | | | | |
| 24.0 | 19.0 | 41.5 | 50 | | | | | |
| 24.0 | 15.0 | 41.5 | 44 | | | | | |
| 28.0 | 37.0 | 42.0 | 83 | | | | | |
| 28.0 | 42.5 | 41.5 | 90 | | | | | |
| 30.0 | 45.0 | 42.0 | 100 | | | | | |
| 33.0 | 48.0 | 42.0 | 100 | | | | | |
| 43.0 | 22.0 | 41.5 | 80 | | | | | |
| 30.0 | 45.0 | 57.5 | 125 | | | | | |
| 35.0 | 50.0 | 57.5 | 145 | | | | | |
| 43.0 | 24.0 | 57.5 | 103 | | | | | |
| 45.0 | 57.0 | 57.5 | 185 | | | | | |
| 60.0 | 45.0 | 57.5 | 192 | | | | | |
| 130.0 | 24.0 | 57.5 | 200 | | | | | |
| 130.0 | 58.0 | 57.5 | 300 | | | | | |

The equivalent heat coefficient "**G** (**mW**/**°C**)" is given for measuring the temperature on the lateral surface of the plastic box as figure 1 shows. By using a thermocouple and avoiding effect of radiation and convection the temperature measured during operation conditions should be a result of the dissipated power divided by the equivalent heat coefficient.





Self Heating by power dissipation & equivalent heat coefficient

The I_{RMS} and consequently the power dissipation must be limited during operation in order to not exceed the maximum limit of ΔT allowed for this series. ΔT_{max} given for this series is equal or lower than 20 °C at rated temperature (70 °C), for higher ambient temperatures ΔT_{max} (T) will have the same derating factor than I_{RMS} versus temperature and then an equivalent derating as per: ambient temperatures ΔT_{max} (T) will have the same derating factor than I_{RMS} versus temperature and then an equivalent derating as per:

$$\Delta T_{\text{max}}$$
 (T) = (Factor)² × ΔT (70 °C).

For any particular I_{RMS} the ΔT may be calculated by:

$$\Delta T$$
 (°C) = P_{dis} (mW) / G(mW/°C).

Where ΔT (°C) is the difference between the temperature measured on the box (see figure 1) and the ambient temperature when capacitor is working during normal operation;

$$\Delta T$$
 (°C) = T_{op} (°C) $- T_{A}$ (°C).

It represents the increasing of temperature provoked by the I_{RMS} during operation. G (mW/°C) is the equivalent heat coefficient described above and P_{dis} (mW) is the dissipated power defined by:

$$P_{dis}$$
 (mW) = ESR_{typ} (m Ω) × I_{rms}^2 (A_{RMS}).

Example for thermal calculation:

We will take as reference B32778G0306K (30 $\mu F/1100 \ V$) type for thermal calculation.

Considering the following load and capacitor characteristics:

 I_{RMS} : 12 A_{RMS} at 20 kHz

T_A: 85 °C

 $30 \times 45 \times 57.5$ box

G (mW/°C): 125

Then we have to find the ESR_{typ} at 20 kHz what is approx . 8.2 m Ω .

So according to:

$$P_{dis}$$
 (mW) = ESR_{typ} (m Ω) × I_{rms}^2 (A_{RMS})

we have the following:

$$P_{dis}$$
 (mW) = 8.2 m $\Omega \times 12 A_{RMS}^2 = 1181 \text{ mW}$

and as per:

$$\Delta T$$
 (°C) = P_{dis} (mW) / G (mW/°C)

we have the following:

$$\Delta T$$
 (°C) = 1181 (mW) / 125 (mW/°C) = 9.5 °C.

What is below of the

$$\Delta T_{\text{max}}$$
 (85 °C) = (Factor)² × ΔT (70 °C) = (0.7)² × 20 °C = 9.8 °C.

On the other hand we may confirm that max I_{RMS} at 20 kHz at 70 °C = 17.5 A_{RMS}

And then max I_{RMS} for 85 °C of ambient temperature is defined as follows:

$$I_{RMS}$$
 (85 °C) = Factor × I_{RMS} (70 °C) = 0.7 × 17.5 A_{RMS} = 12.25 A_{RMS} .

What confirms once again that I_{RMS} (12 A_{RMS} at 20 kHz) is below the max specified for such frequency and ambient temperature.

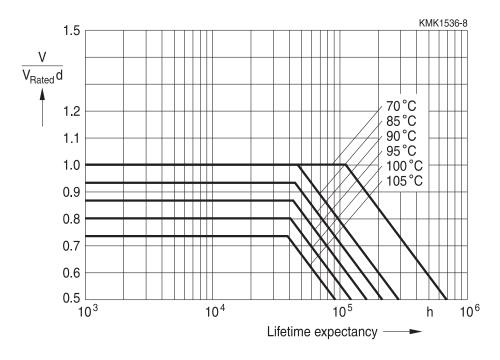




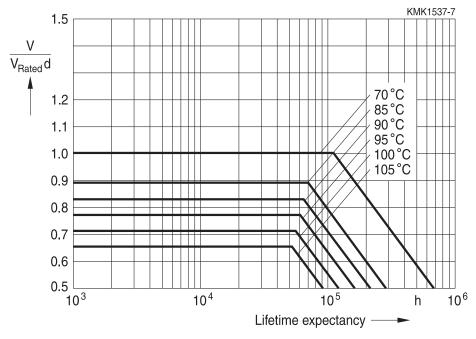
MKP DC link – high density series up to 480 μF

Life time expectancy - typical curves

B3277x-4 (450 V DC)



B3277x-5/8/9/0/1 (575 V DC / 800 V DC / 900 V DC / 1100 V DC / 1300 V DC)



Note: Confidence level of 95%





MKP DC link - high density series up to 480 μF

Testing and Standards

| Test | Reference | Conditions of test | | Performance requirements |
|---|---|---|------------------|--|
| Electrical parameters (Routine test) | IEC61071:2007 | Voltage between terminals, 1.5 V_R , during 10 s Insulation resistance, R_{ins} at V_R if $V_R < 500$ V or 500 V if $V_R \ge 500$ V Capacitance, C at 1 kHz (room temperature) Dissipation factor, tan δ at 1/10 kHz (room temperature) | | Within specified limits |
| Robustness of termina- tions (Type test) | IEC 60068-2-21-2006 | Tensile strength (tensile strength) (tensile stren | Tensile force | Capacitance and δ within specified limits |
| Resistance to soldering heat (Type test) | IEC 60068-2-20:2008, test Tb, method 1A | Solder bath temperature at 260 ±5 °C, immersion for 10 seconds | | $\Delta C/C_0 \le 2\%$ $ \Delta \tan \delta \le 0.002$ |
| Rapid change of temperature (Type test) | IEC 60384-16:2005 | T_A = lower category temperature T_B = upper category temperature Five cycles, duration t = 30 min. | | $\begin{split} \Delta C/C_0 &\leq 2\% \\ \Delta \ tan \ \delta &\leq 0.002 \\ R_{ins} &\geq 50\% \ of \ initial \ limit \end{split}$ |
| Vibration (Type test) | IEC 60384-16:2005 | Test F _c : vibration sinusoidal Displacement: 0.75 mm Accleration: 98 m/s ² Frequency: 10 Hz 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe | | No visible damage |
| Bump (Type test) | IEC 60384-16:2005 | Test Eb: Total 4000 bumps with 390 m/s² mounted on PCB 6 ms duration | | No visible damage $ \Delta C/C_0 \leq 2\%$ $ \Delta \tan \delta \leq 0.002$ $R_{ins} \geq 50\% \text{ of initial limit}$ |
| Climatic sequence (Type test) | IEC 60384-16:2005 | Dry heat Tb / 16 h Damp heat cyclic, 1st cycle +55 °C / 24 h / 95% 100% RH Cold Ta / 2 h Damp heat cyclic, 5 cycles +55 °C / 24 h / 95% 100% RH | | No visible damage $ \Delta C/C_0 \leq 3\%$ $ \Delta\ tan\ \delta \leq 0.001$ $R_{ins} \geq 50\% \ of \ initial \ limit$ |





MKP DC link – high density series up to 480 μF

| Test | Reference | Conditions of test | Performance |
|--------------|-------------------|--|-------------------------------------|
| | | | requirements |
| Damp heat, | IEC 60384-16:2005 | Test Ca | No visible damage |
| steady state | | 40 °C / 93% RH / 56 days | $ \Delta C/C_0 \leq 5\%$ |
| (Type test) | | | $ \Delta \tan \delta \le 0.005$ |
| | | | $R_{ins} \ge 50\%$ of initial limit |
| Endurance | IEC 60384-16:2005 | 70 °C / 1.25 V _R / 1000 hours or | No visible damage |
| (Type test) | | 85 °C / 1.25 V _{op} / 1000 hours or | $ \Delta C/C_0 \le 5\%$ at 1 kHz |
| | | 100 °C / 1.25 V _{op} / 1000 hours | $ \Delta \tan \delta \le 0.005$ |
| | | · | $R_{ins} \ge 50\%$ of initial limit |

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

| Solder bath temperature | 235 ±5 °C |
|-------------------------|---|
| Soldering time | 2.0 ±0.5 s |
| Immersion depth | 2.0 + 0/-0.5 mm from capacitor body or seating plane |
| Evaluation criteria: | |
| Visual inspection | Wetting of wire surface by new solder ≥90%, free-flowing solder |



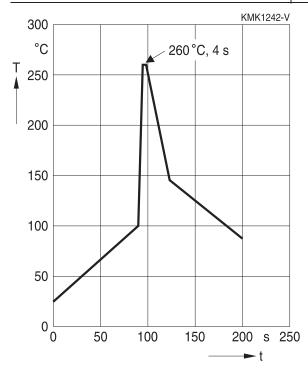


MKP DC link - high density series up to 480 μF

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1. Conditions:

| Series | | Solder bath temperature | Soldering time |
|--------|--|-------------------------|----------------------------|
| MKT | boxed (except 2.5 \times 6.5 \times 7.2 mm) coated | 260 ±5 °C | 10 ±1 s |
| | uncoated (lead spacing >10 mm) | | |
| MFP | | | |
| MKP | (lead spacing >7.5 mm) | | |
| MKT | boxed (case $2.5 \times 6.5 \times 7.2$ mm) | | 5 ±1 s |
| MKP | (lead spacing ≤7.5 mm) | | <4 s |
| MKT | uncoated (lead spacing ≤10 mm) | | recommended soldering |
| | insulated (B32559) | | profile for MKT uncoated |
| | | | (lead spacing ≤ 10 mm) and |
| | | | insulated (B32559) |



| Immersion depth | 2.0 +0/-0.5 mm from capacitor body or seating plane | |
|----------------------|---|--|
| Shield | Heat-absorbing board, (1.5 ± 0.5) mm thick, between | |
| | capacitor body and liquid solder | |
| Evaluation criteria: | | |
| Visual inspection | No visible damage | |
| $\Delta C/C_0$ | 2% for MKT/MKP/MFP | |
| $\Delta C/C_0$ | 5% for EMI suppression capacitors | |
| $tan \ \delta$ | As specified in sectional specification | |





MKP DC link – high density series up to 480 μ F

1.3 General notes on soldering

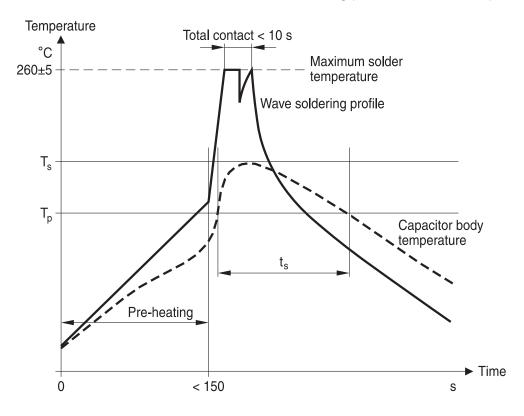
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:

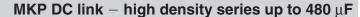


T_s: Capacitor body maximum temperature at wave soldering

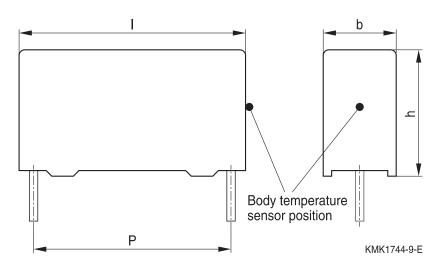
T_p: Capacitor body maximum temperature at pre-heating

KMK1745-A-E









Body temperature should follow the description below:

■ MKP capacitor

During pre-heating: $T_p \le 110 \, ^{\circ}\text{C}$ During soldering: $T_s \le 120 \, ^{\circ}\text{C}$, $t_s \le 45 \, \text{s}$

MKT capacitor

During pre-heating: $T_p \le 125 \,^{\circ}C$ During soldering: $T_s \le 160 \,^{\circ}C$, $t_s \le 45 \,^{\circ}S$

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be ≤ 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to EPCOS Film Capacitor Data Book in case more details are needed.





MKP DC link – high density series up to 480 μ F

Cautions and warnings

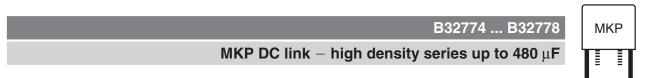
- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of EPCOS.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

| Topic | Safety information | Reference chapter "General technical information" |
|---------------|---|---|
| Storage | Make sure that capacitors are stored within the specified | |
| conditions | range of time, temperature and humidity conditions. | "Storage conditions" |
| Flammability | Avoid external energy, such as fire or electricity (passive | 5.3 |
| | flammability), avoid overload of the capacitors (active | "Flammability" |
| | flammability) and consider the flammability of materials. | |
| Resistance to | Do not exceed the tested ability to withstand vibration. | 5.2 |
| vibration | The capacitors are tested to IEC 60068-2-6:2007. | "Resistance to |
| | EPCOS offers film capacitors specially designed for | vibration" |
| | operation under more severe vibration regimes such as | |
| | those found in automotive applications. Consult our | |
| | catalog "Film Capacitors for Automotive Electronics". | |

| Topic | Safety information | Reference chapter |
|-----------|--|-----------------------|
| | | "Mounting guidelines" |
| Soldering | Do not exceed the specified time or temperature limits | 1 "Soldering" |
| | during soldering. | |
| Cleaning | Use only suitable solvents for cleaning capacitors. | 2 "Cleaning" |





| Topic | Safety information | Reference chapter "Mounting guidelines" |
|--|---|--|
| Embedding of capacitors in finished assemblies | When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types! | 3 "Embedding of capacitors in finished assemblies" |

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MKP DC link - high density series up to 480 μF

Symbols and terms

| Symbol | English | German |
|---------------------|---|---|
| α | Heat transfer coefficient | Wärmeübergangszahl |
| α_{C} | Temperature coefficient of capacitance | Temperaturkoeffizient der Kapazität |
| Α | Capacitor surface area | Kondensatoroberfläche |
| β_{C} | Humidity coefficient of capacitance | Feuchtekoeffizient der Kapazität |
| С | Capacitance | Kapazität |
| C_R | Rated capacitance | Nennkapazität |
| ΔC | Absolute capacitance change | Absolute Kapazitätsänderung |
| ΔC/C | Relative capacitance change (relative deviation of actual value) | Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert) |
| $\Delta C/C_R$ | Capacitance tolerance (relative deviation | Kapazitätstoleranz (relative Abweichung |
| | from rated capacitance) | vom Nennwert) |
| dt | Time differential | Differentielle Zeit |
| Δt | Time interval | Zeitintervall |
| ΔΤ | Absolute temperature change (self-heating) | Absolute Temperaturänderung (Selbsterwärmung) |
| $\Delta tan \delta$ | Absolute change of dissipation factor | Absolute Änderung des Verlustfaktors |
| ΔV | Absolute voltage change | Absolute Spannungsänderung |
| dV/dt | Time differential of voltage function (rate of voltage rise) | Differentielle Spannungsänderung (Spannungsflankensteilheit) |
| $\Delta V/\Delta t$ | Voltage change per time interval | Spannungsänderung pro Zeitintervall |
| E | Activation energy for diffusion | Aktivierungsenergie zur Diffusion |
| ESL | Self-inductance | Eigeninduktivität |
| ESR | Equivalent series resistance | Ersatz-Serienwiderstand |
| f | Frequency | Frequenz |
| f ₁ | Frequency limit for reducing permissible AC voltage due to thermal limits | Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung |
| f_2 | Frequency limit for reducing permissible AC voltage due to current limit | Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung |
| f _r | Resonant frequency | Resonanzfrequenz |
| F_D | Thermal acceleration factor for diffusion | Therm. Beschleunigungsfaktor zur Diffusion |
| F_T | Derating factor | Deratingfaktor |
| i | Current (peak) | Stromspitze |
| Ic | Category current (max. continuous current) | Kategoriestrom (max. Dauerstrom) |





MKP DC link - high density series up to 480 μF

| Symbol | English | German |
|-------------------------------------|--|---|
| I _{RMS} | (Sinusoidal) alternating current, | (Sinusförmiger) Wechselstrom |
| | root-mean-square value | |
| i _z | Capacitance drift | Inkonstanz der Kapazität |
| k_0 | Pulse characteristic | Impulskennwert |
| Ls | Series inductance | Serieninduktivität |
| λ | Failure rate | Ausfallrate |
| λ_{0} | Constant failure rate during useful | Konstante Ausfallrate in der |
| | service life | Nutzungsphase |
| λ_{test} | Failure rate, determined by tests | Experimentell ermittelte Ausfallrate |
| P_{diss} | Dissipated power | Abgegebene Verlustleistung |
| P_{gen} | Generated power | Erzeugte Verlustleistung |
| Q | Heat energy | Wärmeenergie |
| ρ | Density of water vapor in air | Dichte von Wasserdampf in Luft |
| R | Universal molar constant for gases | Allg. Molarkonstante für Gas |
| R | Ohmic resistance of discharge circuit | Ohmscher Widerstand des |
| | | Entladekreises |
| R_i | Internal resistance | Innenwiderstand |
| R _{ins} | Insulation resistance | Isolationswiderstand |
| R_P | Parallel resistance | Parallelwiderstand |
| R_s | Series resistance | Serienwiderstand |
| S | severity (humidity test) | Schärfegrad (Feuchtetest) |
| t | Time | Zeit |
| Т | Temperature | Temperatur |
| τ | Time constant | Zeitkonstante |
| tan δ | Dissipation factor | Verlustfaktor |
| tan $\delta_{\scriptscriptstyle D}$ | Dielectric component of dissipation factor | Dielektrischer Anteil des Verlustfaktors |
| tan $\delta_{\scriptscriptstyle P}$ | Parallel component of dissipation factor | Parallelanteil des Verlfustfaktors |
| tan $\delta_{	extsf{S}}$ | Series component of dissipation factor | Serienanteil des Verlustfaktors |
| T _A | Temperature of the air surrounding the component | Temperatur der Luft, die das Bauteil umgibt |
| T_{max} | Upper category temperature | Obere Kategorietemperatur |
| T _{min} | Lower category temperature | Untere Kategorietemperatur |
| t _{ol} | Operating life at operating temperature | Betriebszeit bei Betriebstemperatur und |
| | and voltage | -spannung |
| T_{op} | Operating temperature, $T_A + \Delta T$ | Beriebstemperatur, $T_A + \Delta T$ |
| T _R | Rated temperature | Nenntemperatur |
| T _{ref} | Reference temperature | Referenztemperatur |
| t _{SL} | Reference service life | Referenz-Lebensdauer |





MKP DC link - high density series up to 480 μF

| Symbol | English | German |
|--------------------|-----------------------------------|---------------------------------------|
| V_{AC} | AC voltage | Wechselspannung |
| V_{C} | Category voltage | Kategoriespannung |
| $V_{\text{C,RMS}}$ | Category AC voltage | (Sinusförmige) |
| | | Kategorie-Wechselspannung |
| V_{CD} | Corona-discharge onset voltage | Teilentlade-Einsatzspannung |
| V_{ch} | Charging voltage | Ladespannung |
| V_{DC} | DC voltage | Gleichspannung |
| V_{FB} | Fly-back capacitor voltage | Spannung (Flyback) |
| V_{i} | Input voltage | Eingangsspannung |
| V_{o} | Output voltage | Ausgangssspannung |
| V_{op} | Operating voltage | Betriebsspannung |
| V_p | Peak pulse voltage | Impuls-Spitzenspannung |
| V_{pp} | Peak-to-peak voltage Impedance | Spannungshub |
| V_R | Rated voltage | Nennspannung |
| ν̂ _R | Amplitude of rated AC voltage | Amplitude der Nenn-Wechselspannung |
| V_{RMS} | (Sinusoidal) alternating voltage, | (Sinusförmige) Wechselspannung |
| | root-mean-square value | |
| V_{SC} | S-correction voltage | Spannung bei Anwendung "S-correction" |
| V_{sn} | Snubber capacitor voltage | Spannung bei Anwendung |
| | | "Beschaltung" |
| Z | Impedance | Scheinwiderstand |
| е | Lead spacing | Rastermaß |



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